



# **PRODUCT DATASHEET**



► PCB / CHIP LED

- ▶ 0402 (1005) 0.48t
- ► True Green 530nm

# N0G58S16-5MA



# <u>0402 (1005) 0.48t</u>



# **FEATURES:**

- Package: PCB SMT Package Top View Multi Colours
- Forward Current: 5mA
- Forward Voltage (typ.): 2.9V
- Luminous Intensity (typ.): 20mcd@5mA
- Colour: True Green
- Wavelength (typ.): 530nm
- Viewing angle: 120°
  - Materials:
    - Die: InGaN
    - Resin: Epoxy (Water Clear)
- **Operating Temperature:** -40~+85°C
- Storage Temperature: -40~+100°C
- **ESD:** 500V
- Grouping parameters:
  - Forward voltage
  - Luminous intensity
- Dominant Wavelength
- Soldering methods: Reflow
- Preconditioning: acc. to JEDEC Level 3
- Packing: 8mm tape with max.3000/reel, ø180mm (7")

0402 (1005) 0.48t

# **APPLICATIONS:**

- Indication Light
- Switch light
- Dashboard
- Keyboard
- Consumer Goods



# CHARACTERISTICS:

## Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	lf	10	mA
Peak Forward Current Duty 1/10@10KHz	IFP	100	mA
Reverse Current @5V	IR	50	μΑ
Power Dissipation	PD	32	mW
Electrostatic Discharge	ESD	500	V
Operating Temperature	Topr	-40~+85	°C
Storage Temperature	Т <sub>stg</sub>	-40~+100	°C

## Electrical & Optical Characteristics (Ta=25°C)

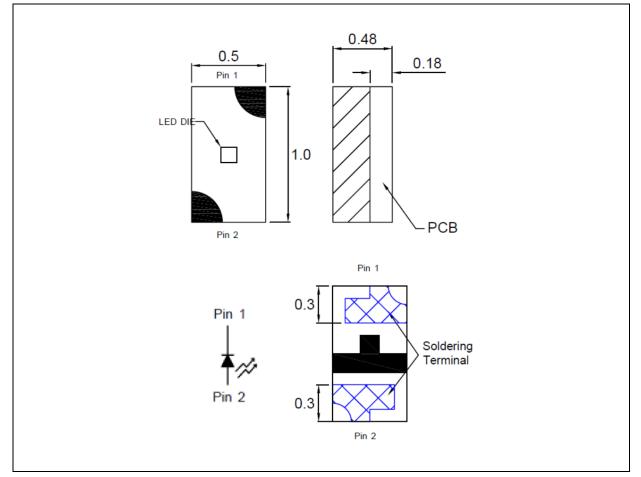
Daramatar	Symphol	Values			Linit	Test
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	VF	2.5		3.2	V	I⊧=5mA
Luminous Intensity	Iv	125	250		mcd	I <sub>F</sub> =5mA
Dominant Wavelength	$\lambda_{D}$		530		nm	I⊧=5mA
Spectral Line Half Bandwidth	Δλ		36		nm	I⊧=5mA
Viewing Angle	2 <b>θ</b> 1/2		130		deg	I⊧=5mA

1. Luminous intensity ( $I_V$ ) ±15%, Forward Voltage ( $V_F$ ) ±0.1V



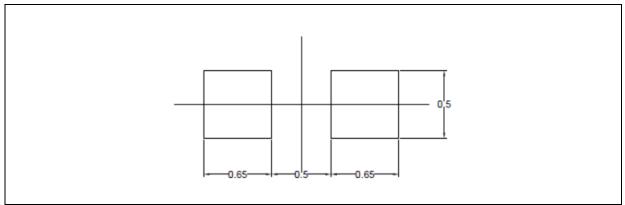
# **OUTLINE DIMENSION:**

### Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

### Recommended Soldering Pad Dimension:



1. Dimensions are in millimetre (mm).

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2. Tolerance  $\pm 0.1$ mm with angle tolerance  $\pm 0.5^{\circ}$ .



## **BINNING GROUPS:**

5			
Code	Min.	Max.	Unit
1	2.5	2.6	
2	2.6	2.7	
3	2.7	2.8	
4	2.8	2.9	V
5	2.9	3.0	
6	3.0	3.1	
7	3.1	3.2	

## Forward Voltage Classifications (I<sub>F</sub> = 5mA):

## Luminous Intensity Classifications (I<sub>F</sub> = 5mA):

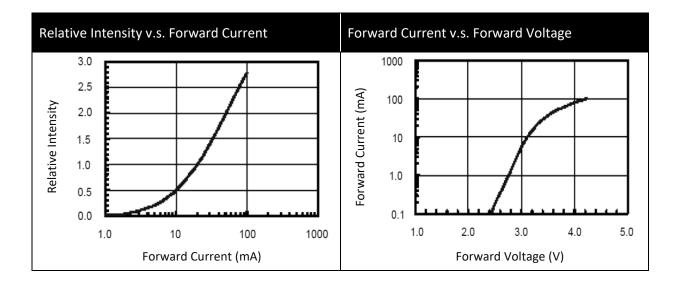
Code	Min.	Max.	Unit
R	125	200	
S	200	320	mcd
Т	320	500	

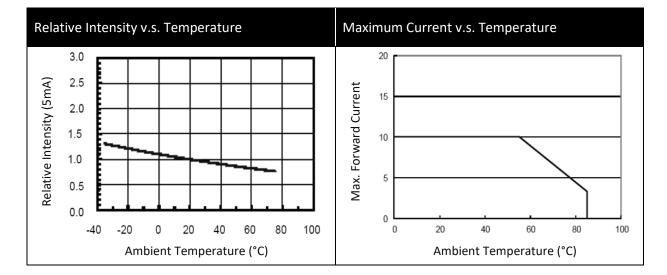
## Dominant Wavelength Classifications (I<sub>F</sub> = 5mA):

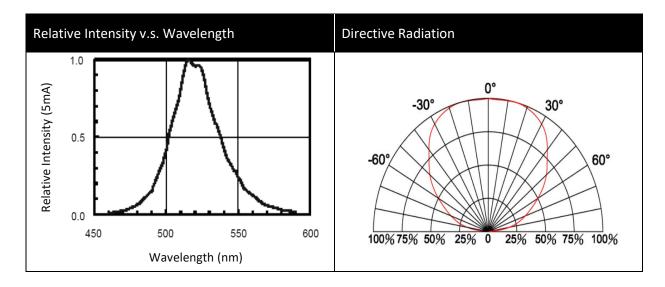
	1 1		
Code	Min.	Max.	Unit
524-526	524	526	
526-528	526	528	
528-530	528	530	
530-532	530	532	nm
532-534	532	534	
534-536	534	536	



# **ELECTRO-OPTICAL CHARACTERISTICS:**



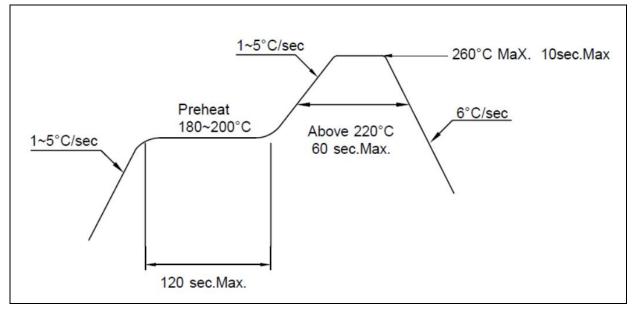






# **RECOMMENDED SOLDERING PROFILE:**

### Lead-free Solder:



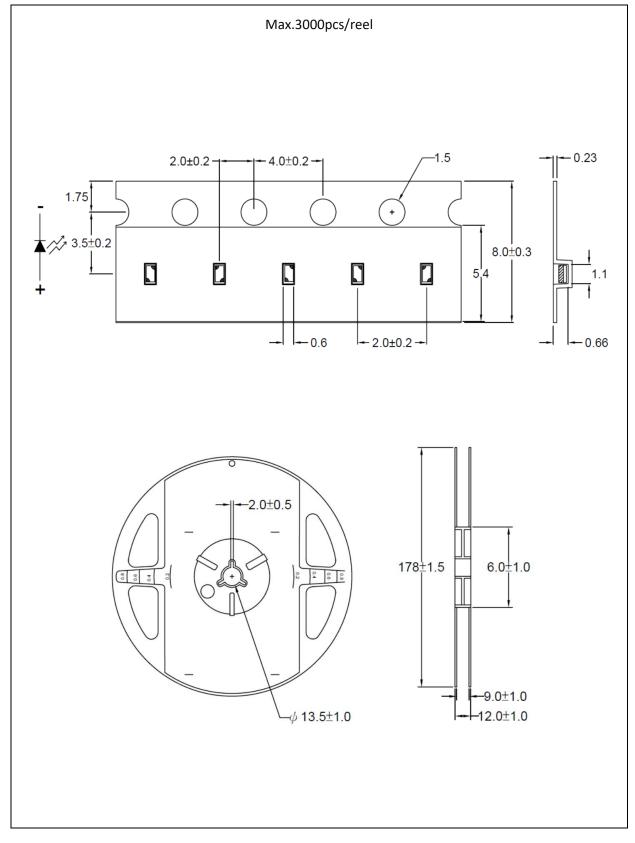
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



# **PACKING SPECIFICATION:**

#### Reel Dimension:



## **PRECAUTIONS OF USE:**



#### Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

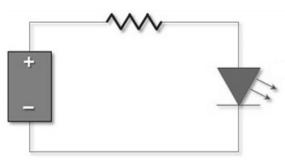
#### Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 72hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

#### **Testing Circuit:**



Must apply resistor(s) for protection (over current proof).

#### Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

#### ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



# **REVISION RECORD:**

Version	Date	Summary of Revision
A1.0	19/09/2019	Datasheet set-up.
A1.1	25/10/2021	New datasheet format.